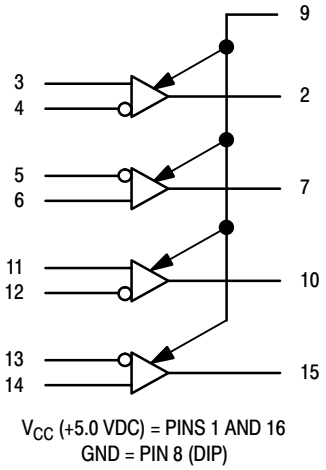
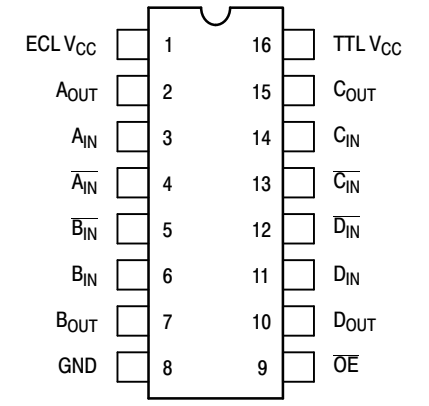


Figure 1. Logic Diagram



Pin assignment is for Dual−in−Line Package.

Figure 2. Dip Pin Assignment

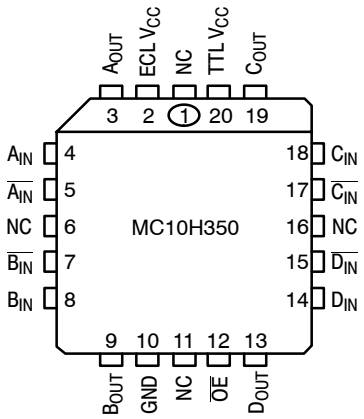


Figure 3. PLCC−20 Pin Assignment

Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{CC}	Power Supply (V_{EE} = GND)	7.0	Vdc
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range − Plastic	−55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 2. ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V ±5%) (Note 1)

Symbol	Characteristic		T_A = 0°C to 75°C Min	T_A = 0°C to 75°C Max	Unit
I_{CC}	Power Supply Current	TTL ECL	– –	20 12	mA
I_{IH} I_{INH}	Input Current High	Pin 9 Others	– –	20 50	μA
I_{IL} I_{INL}	Input Current Low	Pin 9 Others	– –	–0.6 50	mA μA
V_{IH}	Input Voltage High	Pin 9	2.0	–	Vdc
V_{IL}	Input Voltage Low	Pin 9	–	0.8	Vdc
V_{DIFF}	Differential Input Voltage (Note 1) Pins 3–6, 11–14 (1)		350	–	mV
V_{CM}	Voltage Common Mode Pins 3–6, 11–14		2.8	V_{CC}	Vdc
V_{OH}	Output Voltage High I_{OH} = 3.0 mA		2.7	–	Vdc
V_{OL}	Output Voltage Low I_{OL} = 20 mA		–	0.5	Vdc
I_{OS}	Short Circuit Current V_{OUT} = 0 V		–60	–150	mA
I_{OZH}	Output Disable Current High V_{OUT} = 2.7 V		–	50	μA
I_{OZL}	Output Disable Current Low V_{OUT} = 0.5 V		–	–50	μA

*Positive Emitter Coupled Logic

1. Common mode input voltage to pins 3–4, 5–6, 11–12, 13–14 must be between the values of 2.8 V and 5.0 V. This common mode input voltage range includes the differential input swing.
2. For single–ended use, apply 3.75 V (V_{BB}) to either input depending on output polarity required. Signal level range to other input is 3.3 V to 4.2 V.
3. Any unused gates should have the inverting inputs tied to V_{CC} and the noninverting inputs tied to ground to prevent output glitching.

Table 3. AC PARAMETERS (C_L = 50 pF) (V_{CC} = 5.0 ± 5%) (T_A = 0°C to 75°C)

Symbol	Characteristic	T_A = 0°C to 75°C Min	T_A = 0°C to 75°C Max	Unit
t_{pd}	Propagation Delay Data (50% to 1.5 V)	1.5	5.0	ns
t_r	Rise Time (Note 4)	0.3	1.6	ns
t_f	Fall Time (Note 4)	0.3	1.6	ns
t_{pdLZ} t_{pdHZ}	Output Disable Time	2.0 2.0	6.0 6.0	ns
t_{pdZL} t_{pdZH}	Output Enable Time	2.0 2.0	8.0 8.0	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. 1.0 V to 2.0 V w/50 pF into 500 Ω.

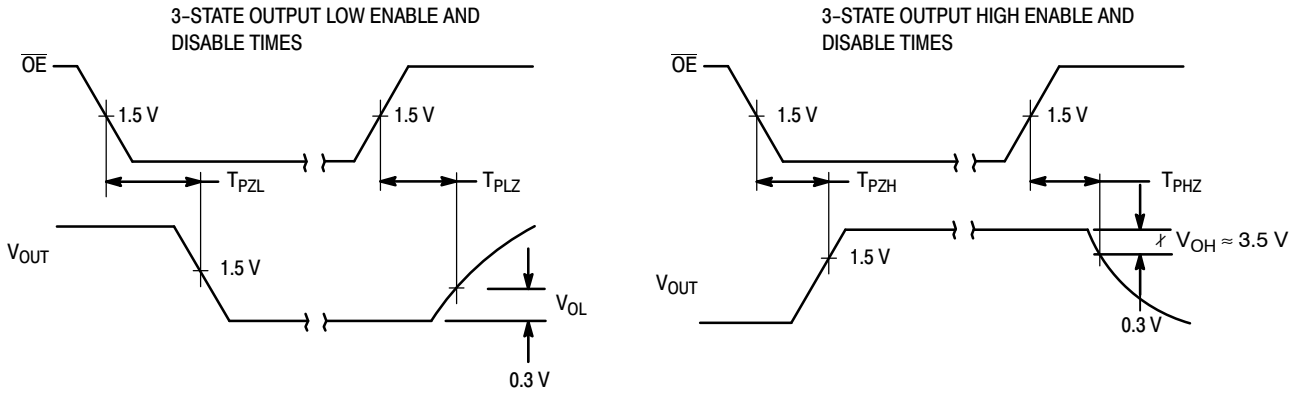
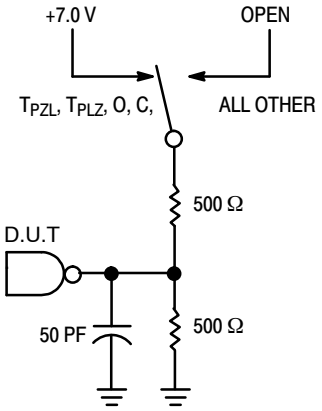


Figure 4. 3−State Switching Waveforms



*INCLUDES JIG AND PROBE CAPACITANCE

Application Note: Pin 9 is an $\overline{OE}$ and the MC10H350 is disabled when $\overline{OE}$ is at V_{IH} or higher.

Figure 5. Test Load

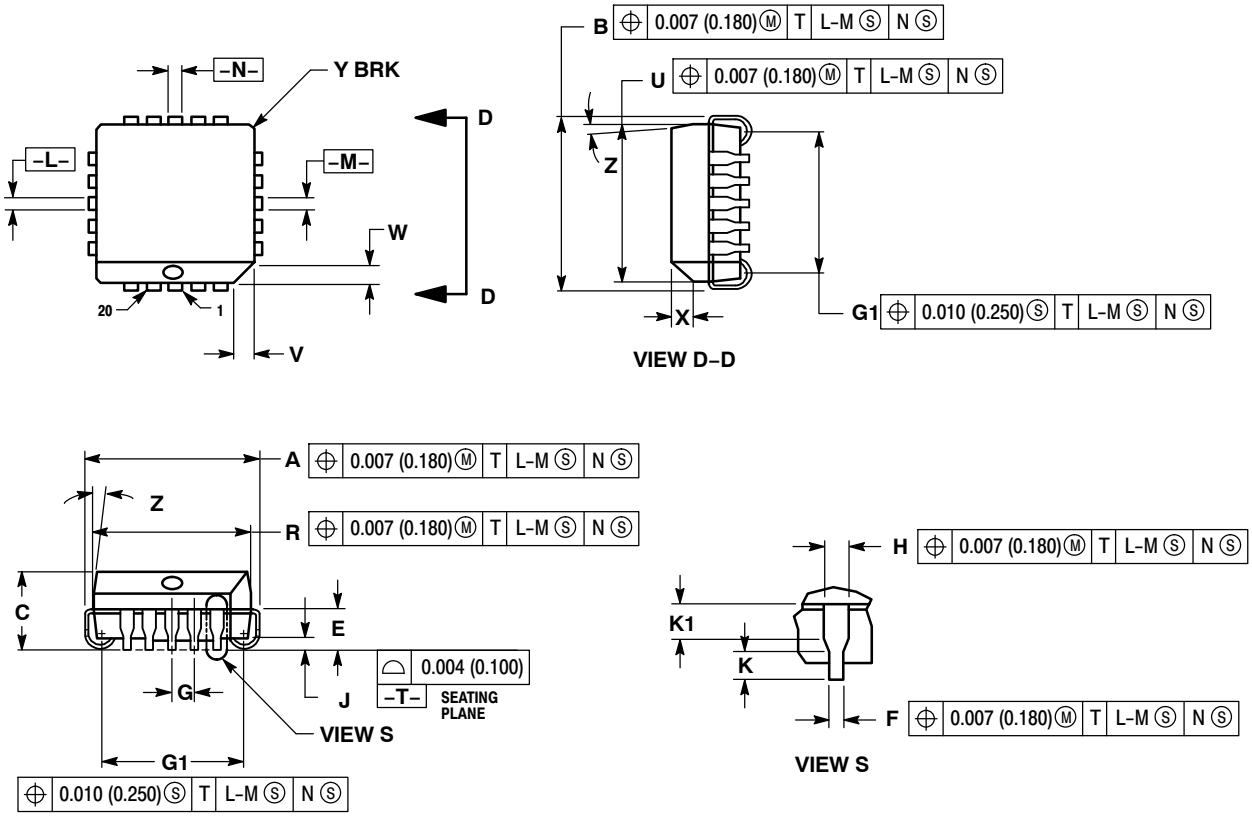
ORDERING INFORMATION

Device	Package	Shipping†
MC10H350FNG	PLCC−20 (Pb−Free)	46 Units / Rail
MC10H350FNR2G	PLCC−20 (Pb−Free)	500 / Tape & Reel
MC10H350P	PDIP−16	25 Unit / Rail
MC10H350PG	PDIP−16 (Pb−Free)	25 Unit / Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

20 LEAD PLCC
CASE 775−02
ISSUE F

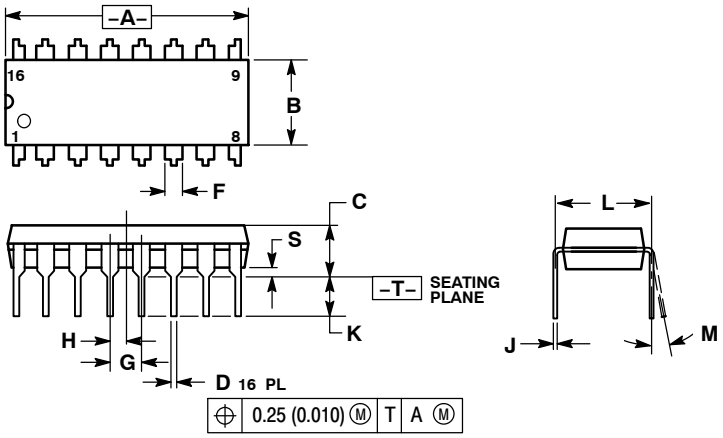


NOTES:
1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
2. DIMENSIONS IN INCHES.
3. DATUMS −L−, −M−, AND −N− DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM −T−, SEATING PLANE.
5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.021	0.33	0.53
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	−−−	0.51	−−−
K	0.025	−−−	0.64	−−−
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	−−−	0.020	−−−	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	−−−	1.02	−−−

PACKAGE DIMENSIONS

PDIP−16
P SUFFIX
CASE 648−08
ISSUE T



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

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